



Product Change Notification

Change Notification #: 117348 - 00
Change Title: Intel® Server System R2312WTTYSR, PCN 117348-00, Label, 1100W Power Supply Fan label location change
Date of Publication: December 16, 2019

Key Characteristics of the Change:
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	December 31, 2019
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System listed in the "Products Affected" table below.

Intel is changing the location of the 1100W power supply fan label so that the label is covered and protected by the power supply chassis.



Figure 1. Previous Label Location

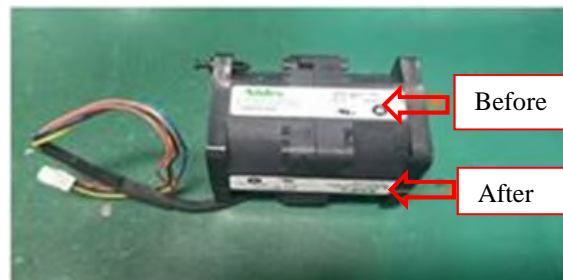


Figure 2. Label Change from "Before" to "After"



Figure 3. Label is now covered and protected by power supply chassis

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2312WTTYSR	975761	J11495-019	J11495-020

PCN Revision History:

Date of Revision:

December 16, 2019

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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